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"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "[Embedded - Microcontrollers](#)"

Details

| | |
|----------------------------|---|
| Product Status | Active |
| Core Processor | PIC |
| Core Size | 8-Bit |
| Speed | 4MHz |
| Connectivity | - |
| Peripherals | POR, WDT |
| Number of I/O | 5 |
| Program Memory Size | 768B (512 x 12) |
| Program Memory Type | OTP |
| EEPROM Size | - |
| RAM Size | 25 x 8 |
| Voltage - Supply (Vcc/Vdd) | 3V ~ 5.5V |
| Data Converters | - |
| Oscillator Type | Internal |
| Operating Temperature | -40°C ~ 85°C (TA) |
| Mounting Type | Surface Mount |
| Package / Case | 8-VDFN Exposed Pad |
| Supplier Device Package | 8-DFN-S (6x5) |
| Purchase URL | https://www.e-xfl.com/product-detail/microchip-technology/pic12c508a-04i-mf |

3.0 ARCHITECTURAL OVERVIEW

The high performance of the PIC12C5XX family can be attributed to a number of architectural features commonly found in RISC microprocessors. To begin with, the PIC12C5XX uses a Harvard architecture in which program and data are accessed on separate buses. This improves bandwidth over traditional von Neumann architecture where program and data are fetched on the same bus. Separating program and data memory further allows instructions to be sized differently than the 8-bit wide data word. Instruction opcodes are 12-bits wide making it possible to have all single word instructions. A 12-bit wide program memory access bus fetches a 12-bit instruction in a single cycle. A two-stage pipeline overlaps fetch and execution of instructions. Consequently, all instructions (33) execute in a single cycle (1 μ s @ 4MHz) except for program branches.

The table below lists program memory (EPROM), data memory (RAM), ROM memory, and non-volatile (EEPROM) for each device.

| Device | Memory | | | |
|-------------|---------------|-------------|----------|-------------|
| | EPROM Program | ROM Program | RAM Data | EEPROM Data |
| PIC12C508 | 512 x 12 | | 25 | |
| PIC12C509 | 1024 x 12 | | 41 | |
| PIC12C508A | 512 x 12 | | 25 | |
| PIC12C509A | 1024 x 12 | | 41 | |
| PIC12CR509A | | 1024 x 12 | 41 | |
| PIC12CE518 | 512 x 12 | | 25 x 8 | 16 x 8 |
| PIC12CE519 | 1024 x 12 | | 41 x 8 | 16 x 8 |

The PIC12C5XX can directly or indirectly address its register files and data memory. All special function registers including the program counter are mapped in the data memory. The PIC12C5XX has a highly orthogonal (symmetrical) instruction set that makes it possible to carry out any operation on any register using any addressing mode. This symmetrical nature and lack of 'special optimal situations' make programming with the PIC12C5XX simple yet efficient. In addition, the learning curve is reduced significantly.

The PIC12C5XX device contains an 8-bit ALU and working register. The ALU is a general purpose arithmetic unit. It performs arithmetic and Boolean functions between data in the working register and any register file.

The ALU is 8-bits wide and capable of addition, subtraction, shift and logical operations. Unless otherwise mentioned, arithmetic operations are two's complement in nature. In two-operand instructions, typically one operand is the W (working) register. The other operand is either a file register or an immediate constant. In single operand instructions, the operand is either the W register or a file register.

The W register is an 8-bit working register used for ALU operations. It is not an addressable register.

Depending on the instruction executed, the ALU may affect the values of the Carry (C), Digit Carry (DC), and Zero (Z) bits in the STATUS register. The C and DC bits operate as a borrow and digit borrow out bit, respectively, in subtraction. See the SUBWF and ADDWF instructions for examples.

A simplified block diagram is shown in Figure 3-1, with the corresponding device pins described in Table 3-1.

4.4 OPTION Register

The OPTION register is a 8-bit wide, write-only register which contains various control bits to configure the Timer0/WDT prescaler and Timer0.

By executing the OPTION instruction, the contents of the W register will be transferred to the OPTION register. A RESET sets the OPTION<7:0> bits.

Note: If TRIS bit is set to '0', the wake-up on change and pull-up functions are disabled for that pin; i.e., note that TRIS overrides OPTION control of $\overline{\text{GPPU}}$ and $\overline{\text{GPWU}}$.

Note: If the T0CS bit is set to '1', GP2 is forced to be an input even if TRIS GP2 = '0'.

FIGURE 4-5: OPTION REGISTER

| W-1 | W-1 | W-1 | W-1 | W-1 | W-1 | W-1 | W-1 |
|--------------------------|--------------------------|------|------|-----|-----|-----|------|
| $\overline{\text{GPWU}}$ | $\overline{\text{GPPU}}$ | T0CS | T0SE | PSA | PS2 | PS1 | PS0 |
| bit7 | 6 | 5 | 4 | 3 | 2 | 1 | bit0 |

W = Writable bit
U = Unimplemented bit
- n = Value at POR reset
Reference Table 4-1 for other resets.

bit 7: **$\overline{\text{GPWU}}$** : Enable wake-up on pin change (GP0, GP1, GP3)
1 = Disabled
0 = Enabled

bit 6: **$\overline{\text{GPPU}}$** : Enable weak pull-ups (GP0, GP1, GP3)
1 = Disabled
0 = Enabled

bit 5: **T0CS**: Timer0 clock source select bit
1 = Transition on T0CKI pin
0 = Transition on internal instruction cycle clock, Fosc/4

bit 4: **T0SE**: Timer0 source edge select bit
1 = Increment on high to low transition on the T0CKI pin
0 = Increment on low to high transition on the T0CKI pin

bit 3: **PSA**: Prescaler assignment bit
1 = Prescaler assigned to the WDT
0 = Prescaler assigned to Timer0

bit 2-0: **PS2:PS0**: Prescaler rate select bits

| Bit Value | Timer0 Rate | WDT Rate |
|-----------|-------------|----------|
| 000 | 1 : 2 | 1 : 1 |
| 001 | 1 : 4 | 1 : 2 |
| 010 | 1 : 8 | 1 : 4 |
| 011 | 1 : 16 | 1 : 8 |
| 100 | 1 : 32 | 1 : 16 |
| 101 | 1 : 64 | 1 : 32 |
| 110 | 1 : 128 | 1 : 64 |
| 111 | 1 : 256 | 1 : 128 |

5.0 I/O PORT

As with any other register, the I/O register can be written and read under program control. However, read instructions (e.g., `MOVF GPIO, W`) always read the I/O pins independent of the pin's input/output modes. On RESET, all I/O ports are defined as input (inputs are at hi-impedance) since the I/O control registers are all set. See Section 7.0 for SCL and SDA description for PIC12CE5XX.

5.1 GPIO

GPIO is an 8-bit I/O register. Only the low order 6 bits are used (GP5:GP0). Bits 7 and 6 are unimplemented and read as '0's. Please note that GP3 is an input only pin. The configuration word can set several I/O's to alternate functions. When acting as alternate functions the pins will read as '0' during port read. Pins GP0, GP1, and GP3 can be configured with weak pull-ups and also with wake-up on change. The wake-up on change and weak pull-up functions are not pin selectable. If pin 4 is configured as MCLR, weak pull-up is always on and wake-up on change for this pin is not enabled.

5.2 TRIS Register

The output driver control register is loaded with the contents of the W register by executing the `TRIS f` instruction. A '1' from a TRIS register bit puts the corresponding output driver in a hi-impedance mode. A '0' puts the contents of the output data latch on the selected pins, enabling the output buffer. The exceptions are GP3 which is input only and GP2 which may be controlled by the option register, see Figure 4-5.

Note: A read of the ports reads the pins, not the output data latches. That is, if an output driver on a pin is enabled and driven high, but the external system is holding it low, a read of the port will indicate that the pin is low.

The TRIS registers are "write-only" and are set (output drivers disabled) upon RESET.

5.3 I/O Interfacing

The equivalent circuit for an I/O port pin is shown in Figure 5-1. All port pins, except GP3 which is input only, may be used for both input and output operations. For input operations these ports are non-latching. Any input must be present until read by an input instruction (e.g., `MOVF GPIO, W`). The outputs are latched and remain unchanged until the output latch is rewritten. To use a port pin as output, the corresponding direction control bit in TRIS must be cleared (= 0). For use as an input, the corresponding TRIS bit must be set. Any I/O pin (except GP3) can be programmed individually as input or output.

FIGURE 5-1: EQUIVALENT CIRCUIT FOR A SINGLE I/O PIN

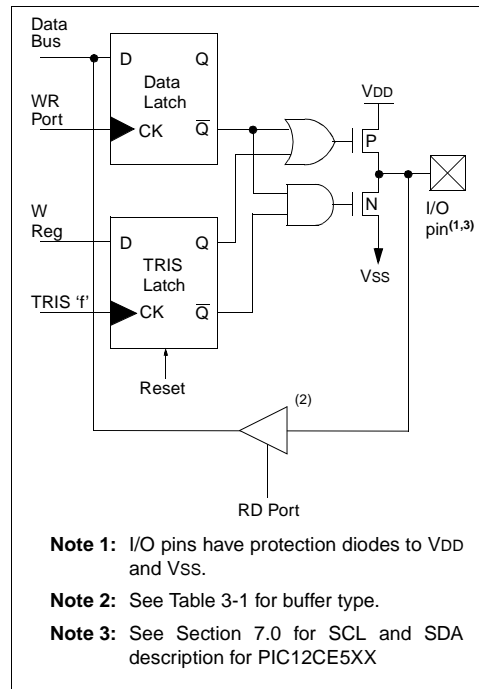


TABLE 5-1: SUMMARY OF PORT REGISTERS

| Address | Name | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | Value on Power-On Reset | Value on All Other Resets |
|---------|---|-------|-------|-------|-----------------|-----------------|-------|-------|-------|-------------------------|---------------------------|
| N/A | TRIS | — | — | | | | | | | --11 1111 | --11 1111 |
| N/A | OPTION | GPWU | GPPU | T0CS | T0SE | PSA | PS2 | PS1 | PS0 | 1111 1111 | 1111 1111 |
| 03H | STATUS | GPWUF | — | PAO | \overline{TO} | \overline{PD} | Z | DC | C | 0001 1xxx | q00q quuu ⁽¹⁾ |
| 06h | GPIO (PIC12C508/ PIC12C509/ PIC12C508A/ PIC12C509A/ PIC12CR509A) | — | — | GP5 | GP4 | GP3 | GP2 | GP1 | GP0 | --xx xxxx | --uu uuuu |
| 06h | GPIO (PIC12CE518/ PIC12CE519) | SCL | SDA | GP5 | GP4 | GP3 | GP2 | GP1 | GP0 | 11xx xxxx | 11uu uuuu |

Legend: Shaded cells not used by Port Registers, read as '0', — = unimplemented, read as '0', x = unknown, u = unchanged, q = see tables in Section 8.7 for possible values.

Note 1: If reset was due to wake-up on change, then bit 7 = 1. All other resets will cause bit 7 = 0.

5.4 I/O Programming Considerations

5.4.1 BI-DIRECTIONAL I/O PORTS

Some instructions operate internally as read followed by write operations. The BCF and BSF instructions, for example, read the entire port into the CPU, execute the bit operation and re-write the result. Caution must be used when these instructions are applied to a port where one or more pins are used as input/outputs. For example, a BSF operation on bit5 of GPIO will cause all eight bits of GPIO to be read into the CPU, bit5 to be set and the GPIO value to be written to the output latches. If another bit of GPIO is used as a bi-directional I/O pin (say bit0) and it is defined as an input at this time, the input signal present on the pin itself would be read into the CPU and rewritten to the data latch of this particular pin, overwriting the previous content. As long as the pin stays in the input mode, no problem occurs. However, if bit0 is switched into output mode later on, the content of the data latch may now be unknown.

Example 5-1 shows the effect of two sequential read-modify-write instructions (e.g., BCF, BSF, etc.) on an I/O port.

A pin actively outputting a high or a low should not be driven from external devices at the same time in order to change the level on this pin ("wired-or", "wired-and"). The resulting high output currents may damage the chip.

EXAMPLE 5-1: READ-MODIFY-WRITE INSTRUCTIONS ON AN I/O PORT

```

;Initial GPIO Settings
; GPIO<5:3> Inputs
; GPIO<2:0> Outputs
;
;
;          GPIO latch  GPIO pins
;          -----
BCF  GPIO, 5  ;--01 -ppp  --11 pppp
BCF  GPIO, 4  ;--10 -ppp  --11 pppp
MOVLW 007h    ;
TRIS  GPIO    ;--10 -ppp  --11 pppp
;
;Note that the user may have expected the pin
;values to be --00 pppp. The 2nd BCF caused
;GP5 to be latched as the pin value (High).

```

5.4.2 SUCCESSIVE OPERATIONS ON I/O PORTS

The actual write to an I/O port happens at the end of an instruction cycle, whereas for reading, the data must be valid at the beginning of the instruction cycle (Figure 5-2). Therefore, care must be exercised if a write followed by a read operation is carried out on the same I/O port. The sequence of instructions should allow the pin voltage to stabilize (load dependent) before the next instruction, which causes that file to be read into the CPU, is executed. Otherwise, the previous state of that pin may be read into the CPU rather than the new state. When in doubt, it is better to separate these instructions with a NOP or another instruction not accessing this I/O port.

NOTES:

7.0 EEPROM PERIPHERAL OPERATION

This section applies to PIC12CE518 and PIC12CE519 only.

The PIC12CE518 and PIC12CE519 each have 16 bytes of EEPROM data memory. The EEPROM memory has an endurance of 1,000,000 erase/write cycles and a data retention of greater than 40 years. The EEPROM data memory supports a bi-directional 2-wire bus and data transmission protocol. These two-wires are serial data (SDA) and serial clock (SCL), that are mapped to bit6 and bit7, respectively, of the GPIO register (SFR 06h). Unlike the GP0-GP5 that are connected to the I/O pins, SDA and SCL are only connected to the internal EEPROM peripheral. For most applications, all that is required is calls to the following functions:

```
; Byte_Write: Byte write routine
;   Inputs: EEPROM Address    EEADDR
;           EEPROM Data      EEDATA
;   Outputs: Return 01 in W if OK, else
;           return 00 in W
;
; Read_Current: Read EEPROM at address
;               currently held by EE device.
;   Inputs: NONE
;   Outputs: EEPROM Data      EEDATA
;           Return 01 in W if OK, else
;           return 00 in W
;
; Read_Random: Read EEPROM byte at supplied
;               address
;   Inputs: EEPROM Address    EEADDR
;   Outputs: EEPROM Data      EEDATA
;           Return 01 in W if OK,
;           else return 00 in W
```

The code for these functions is available on our website www.microchip.com. The code will be accessed by either including the source code FL51XINC.ASM or by linking FLASH5IX.ASM.

It is very important to check the return codes when using these calls, and retry the operation if unsuccessful. Unsuccessful return codes occur when the EE data memory is busy with the previous write, which can take up to 4 mS.

7.0.1 SERIAL DATA

SDA is a bi-directional pin used to transfer addresses and data into and data out of the device.

For normal data transfer SDA is allowed to change only during SCL low. Changes during SCL high are reserved for indicating the START and STOP conditions.

The EEPROM interface is a 2-wire bus protocol consisting of data (SDA) and a clock (SCL). Although these lines are mapped into the GPIO register, they are not accessible as external pins; only to the internal EEPROM peripheral. SDA and SCL operation is also slightly different than GPO-GP5 as listed below.

Namely, to avoid code overhead in modifying the TRIS register, both SDA and SCL are always outputs. To read data from the EEPROM peripheral requires outputting a '1' on SDA placing it in high-Z state, where only the internal 100K pull-up is active on the SDA line.

SDA:

- Built-in 100K (typical) pull-up to VDD
- Open-drain (pull-down only)
- Always an output
- Outputs a '1' on reset

SCL:

- Full CMOS output
- Always an output
- Outputs a '1' on reset

The following example requires:

- Code Space: 77 words
- RAM Space: 5 bytes (4 are overlayable)
- Stack Levels: 1 (The call to the function itself. The functions do not call any lower level functions.)
- Timing:
 - WRITE_BYTE takes 328 cycles
 - READ_CURRENT takes 212 cycles
 - READ_RANDOM takes 416 cycles.
- IO Pins: 0 (No external IO pins are used)

This code must reside in the lower half of a page. The code achieves it's small size without additional calls through the use of a sequencing table. The table is a list of procedures that must be called in order. The table uses an ADDWF PCL,F instruction, effectively a computed goto, to sequence to the next procedure. However the ADDWF PCL,F instruction yields an 8 bit address, forcing the code to reside in the first 256 addresses of a page.

8.2 Oscillator Configurations

8.2.1 OSCILLATOR TYPES

The PIC12C5XX can be operated in four different oscillator modes. The user can program two configuration bits (FOSC1:FOSC0) to select one of these four modes:

- LP: Low Power Crystal
- XT: Crystal/Resonator
- INTRC: Internal 4 MHz Oscillator
- EXTRC: External Resistor/Capacitor

8.2.2 CRYSTAL OSCILLATOR / CERAMIC RESONATORS

In XT or LP modes, a crystal or ceramic resonator is connected to the GP5/OSC1/CLKIN and GP4/OSC2 pins to establish oscillation (Figure 8-2). The PIC12C5XX oscillator design requires the use of a parallel cut crystal. Use of a series cut crystal may give a frequency out of the crystal manufacturers specifications. When in XT or LP modes, the device can have an external clock source drive the GP5/OSC1/CLKIN pin (Figure 8-3).

FIGURE 8-2: CRYSTAL OPERATION (OR CERAMIC RESONATOR) (XT OR LP OSC CONFIGURATION)

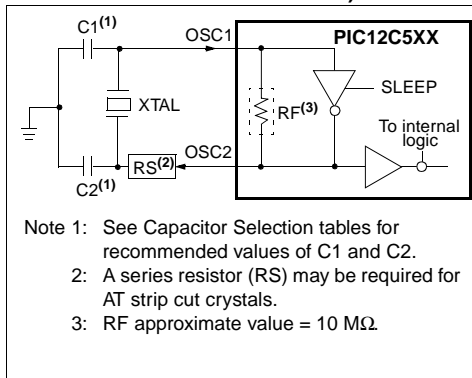


FIGURE 8-3: EXTERNAL CLOCK INPUT OPERATION (XT OR LP OSC CONFIGURATION)

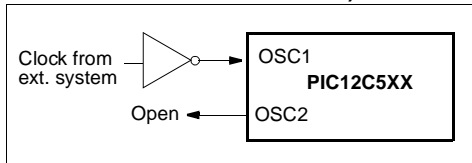


TABLE 8-1: CAPACITOR SELECTION FOR CERAMIC RESONATORS - PIC12C5XX

| Osc Type | Resonator Freq | Cap. Range C1 | Cap. Range C2 |
|----------|----------------|---------------|---------------|
| XT | 4.0 MHz | 30 pF | 30 pF |

These values are for design guidance only. Since each resonator has its own characteristics, the user should consult the resonator manufacturer for appropriate values of external components.

TABLE 8-2: CAPACITOR SELECTION FOR CRYSTAL OSCILLATOR - PIC12C5XX

| Osc Type | Resonator Freq | Cap. Range C1 | Cap. Range C2 |
|----------|-----------------------|---------------|---------------|
| LP | 32 kHz ⁽¹⁾ | 15 pF | 15 pF |
| XT | 200 kHz | 47-68 pF | 47-68 pF |
| | 1 MHz | 15 pF | 15 pF |
| | 4 MHz | 15 pF | 15 pF |

Note 1: For VDD > 4.5V, C1 = C2 ≈ 30 pF is recommended.

These values are for design guidance only. Rs may be required to avoid overdriving crystals with low drive level specification. Since each crystal has its own characteristics, the user should consult the crystal manufacturer for appropriate values of external components.

8.6.1 WDT PERIOD

The WDT has a nominal time-out period of 18 ms, (with no prescaler). If a longer time-out period is desired, a prescaler with a division ratio of up to 1:128 can be assigned to the WDT (under software control) by writing to the OPTION register. Thus, a time-out period of a nominal 2.3 seconds can be realized. These periods vary with temperature, VDD and part-to-part process variations (see DC specs).

Under worst case conditions (VDD = Min., Temperature = Max., max. WDT prescaler), it may take several seconds before a WDT time-out occurs.

8.6.2 WDT PROGRAMMING CONSIDERATIONS

The CLRWDT instruction clears the WDT and the postscaler, if assigned to the WDT, and prevents it from timing out and generating a device RESET.

The SLEEP instruction resets the WDT and the postscaler, if assigned to the WDT. This gives the maximum SLEEP time before a WDT wake-up reset.

FIGURE 8-12: WATCHDOG TIMER BLOCK DIAGRAM

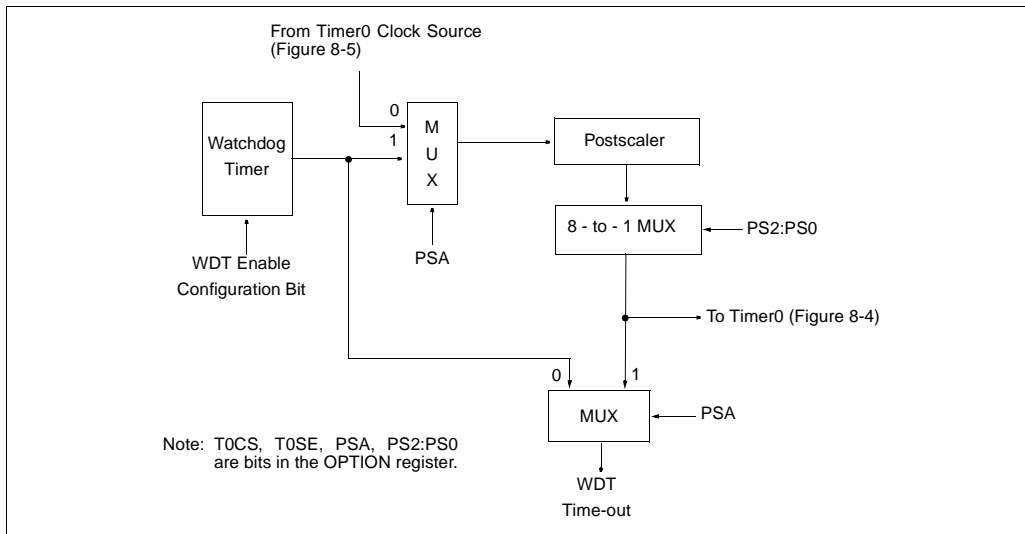


TABLE 8-6: SUMMARY OF REGISTERS ASSOCIATED WITH THE WATCHDOG TIMER

| Address | Name | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | Value on Power-On Reset | Value on All Other Resets |
|---------|--------|-------|-------|-------|-------|-------|-------|-------|-------|-------------------------|---------------------------|
| N/A | OPTION | GPWU | GPPU | T0CS | T0SE | PSA | PS2 | PS1 | PS0 | 1111 1111 | 1111 1111 |

Legend: Shaded boxes = Not used by Watchdog Timer, – = unimplemented, read as '0', u = unchanged

PIC12C5XX

| BSF | Bit Set f | | |
|--------------------|---|-----------|------|
| Syntax: | [<i>label</i>] BSF f,b | | |
| Operands: | $0 \leq f \leq 31$ $0 \leq b \leq 7$ | | |
| Operation: | $1 \rightarrow (f)$ | | |
| Status Affected: | None | | |
| Encoding: | 0101 | bbbf | ffff |
| Description: | Bit 'b' in register 'f' is set. | | |
| Words: | 1 | | |
| Cycles: | 1 | | |
| Example: | BSF | FLAG_REG, | 7 |
| Before Instruction | | | |
| FLAG_REG = 0x0A | | | |
| After Instruction | | | |
| FLAG_REG = 0x8A | | | |

| BTFSC | | Bit Test f, Skip if Clear | |
|--------------------|--|------------------------------|-------------------------|
| Syntax: | [<i>label</i>] BTFSC f,b | | |
| Operands: | 0 ≤ f ≤ 31 0 ≤ b ≤ 7 | | |
| Operation: | skip if (f<b) = 0 | | |
| Status Affected: | None | | |
| Encoding: | 0110 | bbbf | ffff |
| Description: | If bit 'b' in register 'f' is 0 then the next instruction is skipped. If bit 'b' is 0 then the next instruction fetched during the current instruction execution is discarded, and an NOP is executed instead, making this a 2 cycle instruction. | | |
| Words: | 1 | | |
| Cycles: | 1(2) | | |
| Example: | HERE FALSE TRUE | BTFSC GOTO • • • | FLAG, 1 PROCESS_CODE |
| Before Instruction | | | |
| PC | = | address (HERE) | |
| After Instruction | | | |
| if FLAG<1> | = | 0, | |
| PC | = | address (TRUE); | |
| if FLAG<1> | = | 1, | |
| PC | = | address (FALSE) | |

| BTFSS | | Bit Test f, Skip if Set | | | | | | | | | | | | | | | | |
|--------------------|---|-------------------------|--|------|-------|---------|-------|------|--------------|------|---|--|--|---|--|--|---|--|
| Syntax: | [<i>label</i>] BTFSS f,b | | | | | | | | | | | | | | | | | |
| Operands: | 0 ≤ f ≤ 31 0 ≤ b < 7 | | | | | | | | | | | | | | | | | |
| Operation: | skip if (f) = 1 | | | | | | | | | | | | | | | | | |
| Status Affected: | None | | | | | | | | | | | | | | | | | |
| Encoding: | <table border="1"><tr><td>0111</td><td>bbbf</td><td>ffff</td></tr></table> | | | 0111 | bbbf | ffff | | | | | | | | | | | | |
| 0111 | bbbf | ffff | | | | | | | | | | | | | | | | |
| Description: | If bit 'b' in register 'f' is '1' then the next instruction is skipped. If bit 'b' is '1', then the next instruction fetched during the current instruction execution, is discarded and an NOP is executed instead, making this a 2 cycle instruction. | | | | | | | | | | | | | | | | | |
| Words: | 1 | | | | | | | | | | | | | | | | | |
| Cycles: | 1(2) | | | | | | | | | | | | | | | | | |
| Example: | <table><tr><td>HERE</td><td>BTFSS</td><td>FLAG, 1</td></tr><tr><td>FALSE</td><td>GOTO</td><td>PROCESS_CODE</td></tr><tr><td>TRUE</td><td>.</td><td></td></tr><tr><td></td><td>.</td><td></td></tr><tr><td></td><td>.</td><td></td></tr></table> | | | HERE | BTFSS | FLAG, 1 | FALSE | GOTO | PROCESS_CODE | TRUE | . | | | . | | | . | |
| HERE | BTFSS | FLAG, 1 | | | | | | | | | | | | | | | | |
| FALSE | GOTO | PROCESS_CODE | | | | | | | | | | | | | | | | |
| TRUE | . | | | | | | | | | | | | | | | | | |
| | . | | | | | | | | | | | | | | | | | |
| | . | | | | | | | | | | | | | | | | | |
| Before Instruction | | | | | | | | | | | | | | | | | | |
| PC | = | address (HERE) | | | | | | | | | | | | | | | | |
| After Instruction | | | | | | | | | | | | | | | | | | |
| If FLAG<1> | = | 0, | | | | | | | | | | | | | | | | |
| PC | = | address (FALSE); | | | | | | | | | | | | | | | | |
| if FLAG<1> | = | 1, | | | | | | | | | | | | | | | | |
| PC | = | address (TRUE) | | | | | | | | | | | | | | | | |

OPTION Load OPTION Register

Syntax: [label] OPTION
 Operands: None
 Operation: (W) → OPTION
 Status Affected: None
 Encoding:

| | | |
|------|------|------|
| 0000 | 0000 | 0010 |
|------|------|------|

 Description: The content of the W register is loaded into the OPTION register.
 Words: 1
 Cycles: 1
 Example: OPTION

Before Instruction
 W = 0x07
 After Instruction
 OPTION = 0x07

RETLW Return with Literal in W

Syntax: [label] RETLW k
 Operands: $0 \leq k \leq 255$
 Operation: $k \rightarrow (W)$;
 TOS → PC
 Status Affected: None
 Encoding:

| | | |
|------|------|------|
| 1000 | kkkk | kkkk |
|------|------|------|

 Description: The W register is loaded with the eight bit literal 'k'. The program counter is loaded from the top of the stack (the return address). This is a two cycle instruction.

Words: 1
 Cycles: 2
 Example: CALL TABLE ;W contains
 ;table offset
 ;value.
 ;W now has table
 ;value.
 ;
 TABLE ADDWF PC ;W = offset
 RETLW k1 ;Begin table
 RETLW k2 ;
 ;
 ;
 ;
 RETLW kn ; End of table

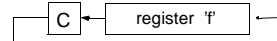
Before Instruction
 W = 0x07
 After Instruction
 W = value of k8

RLF Rotate Left f through Carry

Syntax: [label] RLF f,d
 Operands: $0 \leq f \leq 31$
 $d \in [0,1]$
 Operation: See description below
 Status Affected: C
 Encoding:

| | | |
|------|------|------|
| 0011 | 01df | ffff |
|------|------|------|

 Description: The contents of register 'f' are rotated one bit to the left through the Carry Flag. If 'd' is 0 the result is placed in the W register. If 'd' is 1 the result is stored back in register 'f'.



Words: 1
 Cycles: 1
 Example: RLF REG1,0

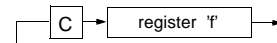
Before Instruction
 REG1 = 1110 0110
 C = 0
 After Instruction
 REG1 = 1110 0110
 W = 1100 1100
 C = 1

RRF Rotate Right f through Carry

Syntax: [label] RRF f,d
 Operands: $0 \leq f \leq 31$
 $d \in [0,1]$
 Operation: See description below
 Status Affected: C
 Encoding:

| | | |
|------|------|------|
| 0011 | 00df | ffff |
|------|------|------|

 Description: The contents of register 'f' are rotated one bit to the right through the Carry Flag. If 'd' is 0 the result is placed in the W register. If 'd' is 1 the result is placed back in register 'f'.



Words: 1
 Cycles: 1
 Example: RRF REG1,0

Before Instruction
 REG1 = 1110 0110
 C = 0
 After Instruction
 REG1 = 1110 0110
 W = 0111 0011
 C = 0

11.1 DC CHARACTERISTICS: PIC12C508/509 (Commercial, Industrial, Extended)

| DC Characteristics Power Supply Pins | | Standard Operating Conditions (unless otherwise specified) Operating Temperature 0°C ≤ TA ≤ +70°C (commercial) -40°C ≤ TA ≤ +85°C (industrial) -40°C ≤ TA ≤ +125°C (extended) | | | | | |
|---|--|--|-----------------------|------------------------------|------------------------------|----------------------------|---|
| Parm No. | Characteristic | Sym | Min | Typ ⁽¹⁾ | Max | Units | Conditions |
| D001 | Supply Voltage | VDD | 2.5 3.0 | | 5.5 5.5 | V V | Fosc = DC to 4 MHz (Commercial/ Industrial) Fosc = DC to 4 MHz (Extended) |
| D002 | RAM Data Retention Voltage ⁽²⁾ | VDR | | 1.5* | | V | Device in SLEEP mode |
| D003 | VDD Start Voltage to ensure Power-on Reset | VPOR | | VSS | | V | See section on Power-on Reset for details |
| D004 | VDD Rise Rate to ensure Power-on Reset | SVDD | 0.05 * | | | V/ms | See section on Power-on Reset for details |
| D010 D010C D010A | Supply Current ⁽³⁾ | IDD | — — — — — | .78 1.1 10 14 14 | 2.4 2.4 27 35 35 | mA mA μA μA μA | XT and EXTRC options ⁽⁴⁾ Fosc = 4 MHz, VDD = 5.5V INTRC Option Fosc = 4 MHz, VDD = 5.5V LP OPTION, Commercial Temperature Fosc = 32 kHz, VDD = 3.0V, WDT disabled LP OPTION, Industrial Temperature Fosc = 32 kHz, VDD = 3.0V, WDT disabled LP OPTION, Extended Temperature Fosc = 32 kHz, VDD = 3.0V, WDT disabled |
| D020 D021 D021B | Power-Down Current ⁽⁵⁾ | IPD | — — — | 0.25 0.25 2 | 4 5 18 | μA μA μA | VDD = 3.0V, Commercial WDT disabled VDD = 3.0V, Industrial WDT disabled VDD = 3.0V, Extended WDT disabled |
| D022 | | ΔIWDT | — — — | 3.75 3.75 3.75 | 8 9 14 | μA μA μA | VDD = 3.0V, Commercial VDD = 3.0V, Industrial VDD = 3.0V, Extended |

* These parameters are characterized but not tested.

Note 1: Data in the Typical ("Typ") column is based on characterization results at 25°C. This data is for design guidance only and is not tested.

2: This is the limit to which VDD can be lowered in SLEEP mode without losing RAM data.

3: The supply current is mainly a function of the operating voltage and frequency. Other factors such as bus loading, oscillator type, bus rate, internal code execution pattern, and temperature also have an impact on the current consumption.

a) The test conditions for all IDD measurements in active operation mode are:

OSC1 = external square wave, from rail-to-rail; all I/O pins tristated, pulled to VSS, T0CKI = VDD, MCLR = VDD; WDT enabled/disabled as specified.

b) For standby current measurements, the conditions are the same, except that the device is in SLEEP mode.

4: Does not include current through Rext. The current through the resistor can be estimated by the formula: IR = VDD/2Rext (mA) with Rext in kOhm.

5: The power down current in SLEEP mode does not depend on the oscillator type. Power down current is measured with the part in SLEEP mode, with all I/O pins in hi-impedance state and tied to VDD or VSS.

TABLE 11-4: TIMING REQUIREMENTS - PIC12C508/C509

| AC Characteristics | | Standard Operating Conditions (unless otherwise specified) | | | | |
|--------------------|----------|---|-----|--------------------|------|-------|
| | | Operating Temperature $0^{\circ}\text{C} \leq T_A \leq +70^{\circ}\text{C}$ (commercial) $-40^{\circ}\text{C} \leq T_A \leq +85^{\circ}\text{C}$ (industrial) $-40^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$ (extended) | | | | |
| | | Operating Voltage V_{DD} range is described in Section 11.1 | | | | |
| Parameter No. | Sym | Characteristic | Min | Typ ⁽¹⁾ | Max | Units |
| 17 | TosH2ioV | OSC1 \uparrow (Q1 cycle) to Port out valid ⁽³⁾ | — | — | 100* | ns |
| 18 | TosH2ioI | OSC1 \uparrow (Q2 cycle) to Port input invalid (I/O in hold time) | TBD | — | — | ns |
| 19 | TioV2osH | Port input valid to OSC1 \uparrow (I/O in setup time) | TBD | — | — | ns |
| 20 | TioR | Port output rise time ^(2, 3) | — | 10 | 25** | ns |
| 21 | TioF | Port output fall time ^(2, 3) | — | 10 | 25** | ns |

* These parameters are characterized but not tested.

** These parameters are design targets and are not tested. No characterization data available at this time.

Note 1: Data in the Typical ("Typ") column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

2: Measurements are taken in EXTRC mode.

3: See Figure 11-1 for loading conditions.

FIGURE 11-4: RESET, WATCHDOG TIMER, AND DEVICE RESET TIMER TIMING - PIC12C508/C509

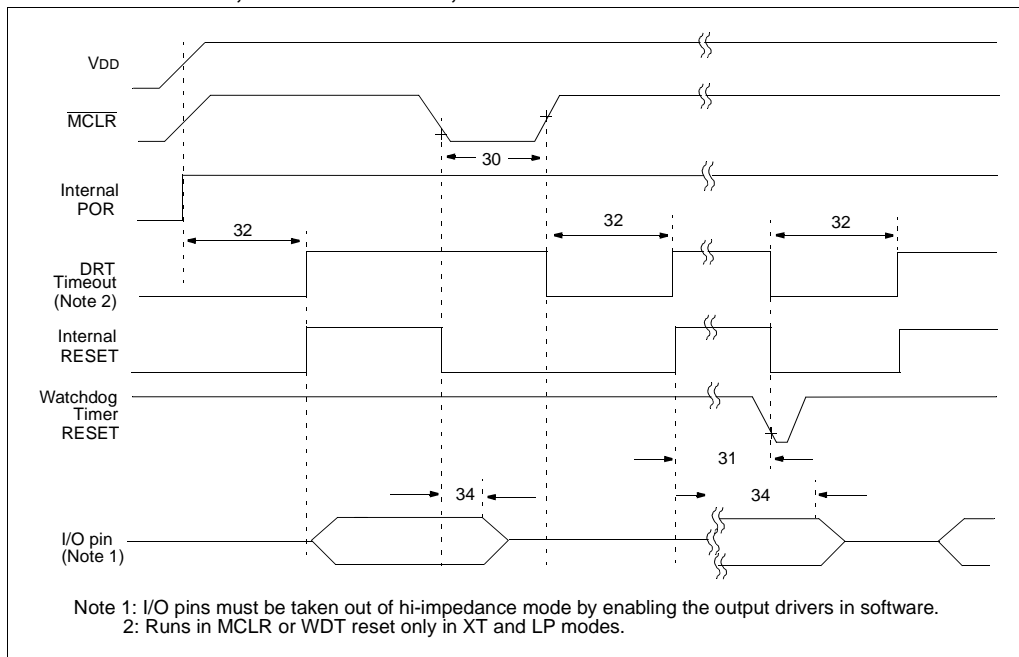


TABLE 11-5: RESET, WATCHDOG TIMER, AND DEVICE RESET TIMER - PIC12C508/C509

| AC Characteristics Standard Operating Conditions (unless otherwise specified) Operating Temperature $0^{\circ}\text{C} \leq T_A \leq +70^{\circ}\text{C}$ (commercial) $-40^{\circ}\text{C} \leq T_A \leq +85^{\circ}\text{C}$ (industrial) $-40^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$ (extended) Operating Voltage VDD range is described in Section 11.1 | | | | | | | |
|--|------|---|-------|--------------------|-------|-------|------------------------|
| Parameter No. | Sym | Characteristic | Min | Typ ⁽¹⁾ | Max | Units | Conditions |
| 30 | TmCL | MCLR Pulse Width (low) | 2000* | — | — | ns | VDD = 5 V |
| 31 | Twdt | Watchdog Timer Time-out Period (No Prescaler) | 9* | 18* | 30* | ms | VDD = 5 V (Commercial) |
| 32 | TDRT | Device Reset Timer Period ⁽²⁾ | 9* | 18* | 30* | ms | VDD = 5 V (Commercial) |
| 34 | TioZ | I/O Hi-impedance from MCLR Low | — | — | 2000* | ns | |

* These parameters are characterized but not tested.

Note 1: Data in the Typical ("Typ") column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 2: See Table 11-6.

TABLE 11-6: DRT (DEVICE RESET TIMER PERIOD - PIC12C508/C509)

| Oscillator Configuration | POR Reset | Subsequent Resets |
|--------------------------|-----------------|-----------------------|
| IntRC & ExtRC | 18 ms (typical) | 300 μ s (typical) |
| XT & LP | 18 ms (typical) | 18 ms (typical) |

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FIGURE 11-5: TIMER0 CLOCK TIMINGS - PIC12C508/C509

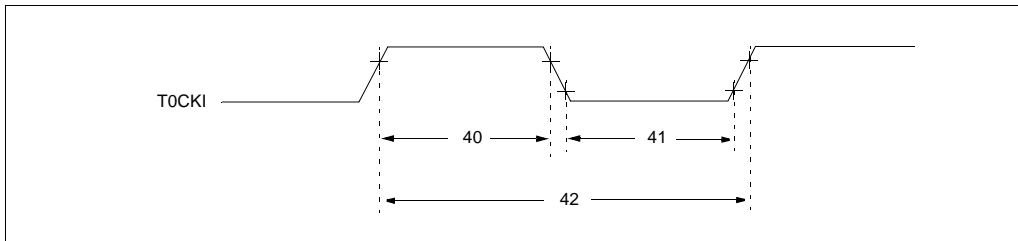


TABLE 11-7: TIMER0 CLOCK REQUIREMENTS - PIC12C508/C509

| AC Characteristics | | | Standard Operating Conditions (unless otherwise specified) | | | | |
|--------------------|------|---------------------------------------|--|--------------------|-----|-------|---|
| | | | Operating Temperature $0^{\circ}\text{C} \leq T_A \leq +70^{\circ}\text{C}$ (commercial) $-40^{\circ}\text{C} \leq T_A \leq +85^{\circ}\text{C}$ (industrial) $-40^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$ (extended) Operating Voltage VDD range is described in Section 11.1. | | | | |
| Parameter No. | Sym | Characteristic | Min | Typ ⁽¹⁾ | Max | Units | Conditions |
| 40 | Tt0H | T0CKI High Pulse Width - No Prescaler | $0.5 T_{CY} + 20^*$ | — | — | ns | |
| | | - With Prescaler | 10^* | — | — | ns | |
| 41 | Tt0L | T0CKI Low Pulse Width - No Prescaler | $0.5 T_{CY} + 20^*$ | — | — | ns | |
| | | - With Prescaler | 10^* | — | — | ns | |
| 42 | Tt0P | T0CKI Period | $20 \text{ or } \frac{T_{CY} + 40^*}{N}$ | — | — | ns | Whichever is greater. N = Prescale Value (1, 2, 4,..., 256) |

* These parameters are characterized but not tested.

Note 1: Data in the Typical ("Typ") column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

12.0 DC AND AC CHARACTERISTICS - PIC12C508/PIC12C509

The graphs and tables provided in this section are for design guidance and are not tested. In some graphs or tables the data presented are outside specified operating range (e.g., outside specified VDD range). This is for information only and devices will operate properly only within the specified range.

The data presented in this section is a statistical summary of data collected on units from different lots over a period of time. "Typical" represents the mean of the distribution while "max" or "min" represents (mean + 3 σ) and (mean - 3 σ) respectively, where σ is standard deviation.

FIGURE 12-1: CALIBRATED INTERNAL RC FREQUENCY RANGE VS. TEMPERATURE (VDD = 2.5V)

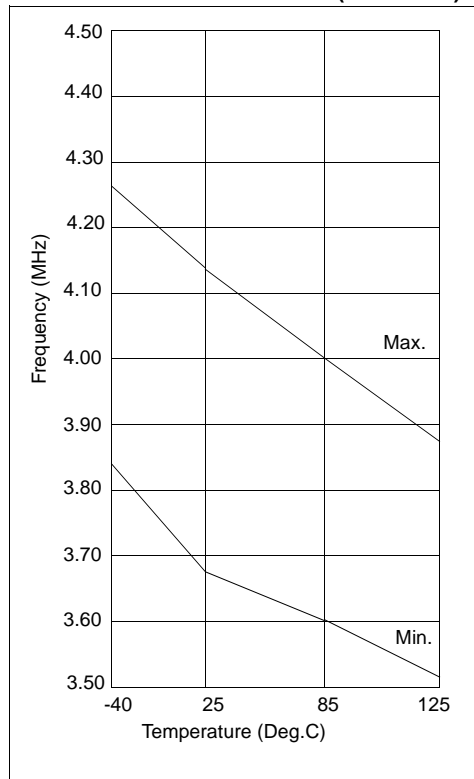
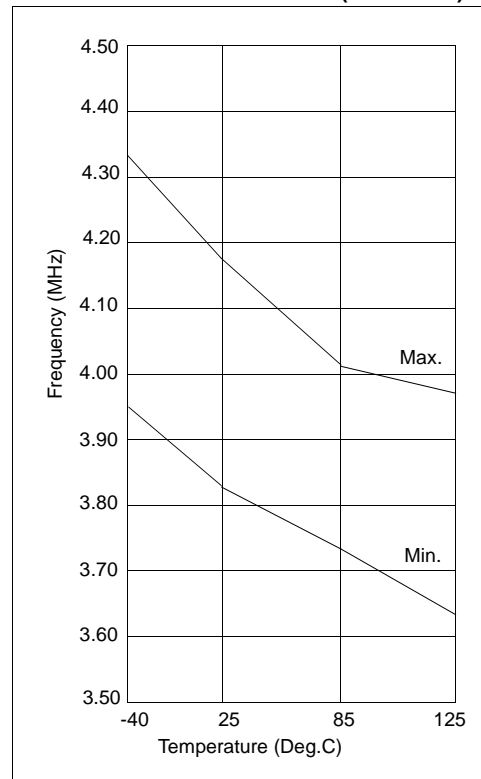


FIGURE 12-2: CALIBRATED INTERNAL RC FREQUENCY RANGE VS. TEMPERATURE (VDD = 5.0V)



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FIGURE 13-3: I/O TIMING - PIC12C508A, PIC12C509A, PIC12CE518, PIC12CE519, PIC12LC508A, PIC12LC509A, PIC12LCR509A, PIC12LCE518 and PIC12LCE519

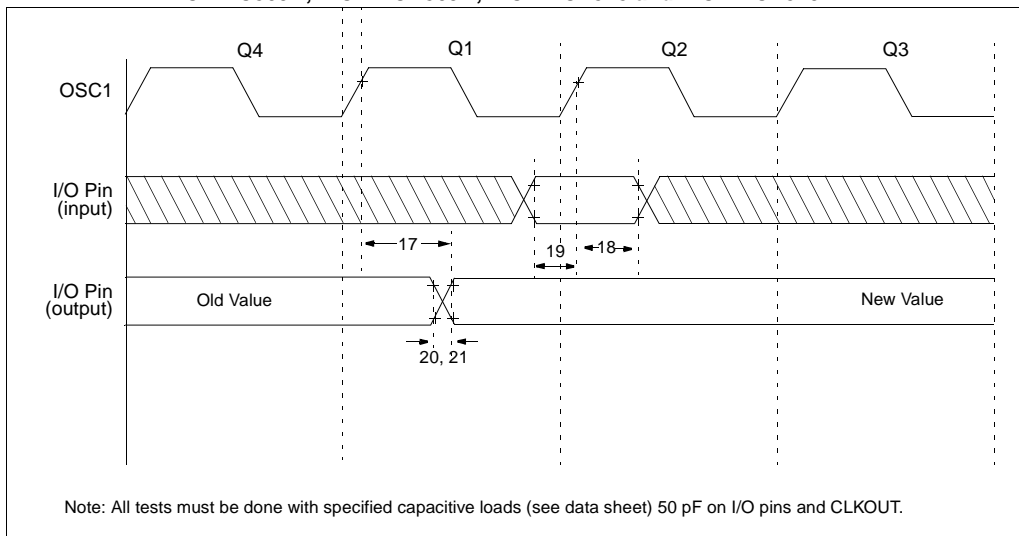


TABLE 13-4: TIMING REQUIREMENTS - PIC12C508A, PIC12C509A, PIC12CE518, PIC12CE519, PIC12LC508A, PIC12LC509A, PIC12LCR509A, PIC12LCE518 and PIC12LCE519

| AC Characteristics | | Standard Operating Conditions (unless otherwise specified) | | | | |
|--------------------|----------|---|-----|--------------------|------|-------|
| | | Operating Temperature $0^{\circ}\text{C} \leq T_A \leq +70^{\circ}\text{C}$ (commercial) $-40^{\circ}\text{C} \leq T_A \leq +85^{\circ}\text{C}$ (industrial) $-40^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$ (extended) | | | | |
| | | Operating Voltage V_{DD} range is described in Section 13.1 | | | | |
| Parameter No. | Sym | Characteristic | Min | Typ ⁽¹⁾ | Max | Units |
| 17 | TosH2ioV | OSC1↑ (Q1 cycle) to Port out valid ⁽³⁾ | — | — | 100* | ns |
| 18 | TosH2ioI | OSC1↑ (Q2 cycle) to Port input invalid (I/O in hold time) | TBD | — | — | ns |
| 19 | TioV2osH | Port input valid to OSC1↑ (I/O in setup time) | TBD | — | — | ns |
| 20 | TioR | Port output rise time ^(2, 3) | — | 10 | 25** | ns |
| 21 | TioF | Port output fall time ^(2, 3) | — | 10 | 25** | ns |

* These parameters are characterized but not tested.

** These parameters are design targets and are not tested. No characterization data available at this time.

Note 1: Data in the Typical ("Typ") column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

2: Measurements are taken in EXTRC mode.

3: See Figure 13-1 for loading conditions.

FIGURE 13-4: RESET, WATCHDOG TIMER, AND DEVICE RESET TIMER TIMING - PIC12C508A, PIC12C509A, PIC12CE518, PIC12CE519, PIC12LC508A, PIC12LC509A, PIC12LCR509A, PIC12LCE518 and PIC12LCE519

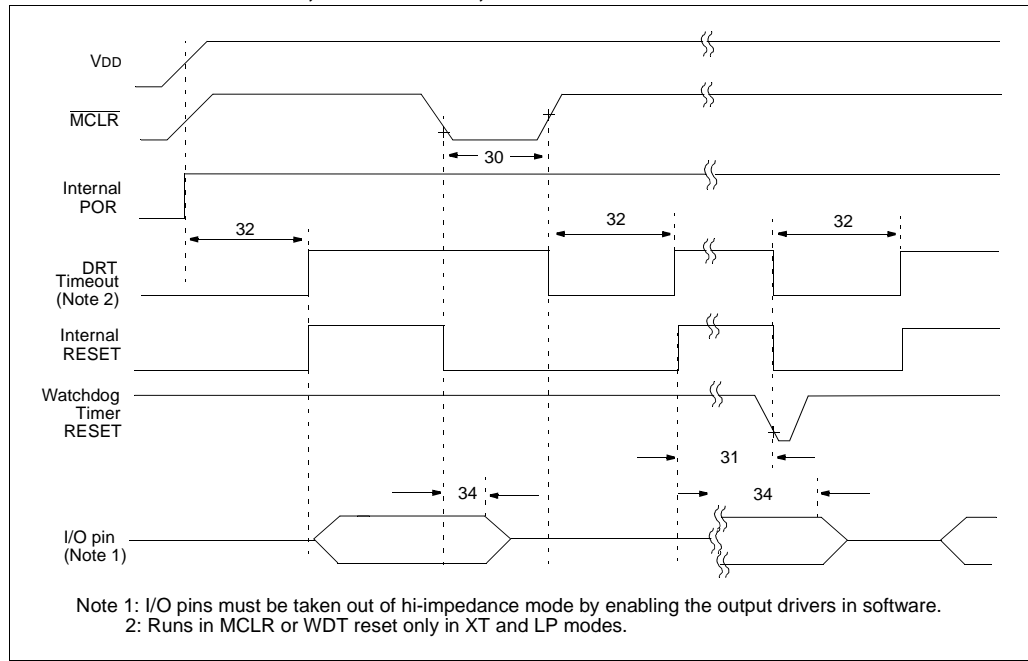


TABLE 13-5: RESET, WATCHDOG TIMER, AND DEVICE RESET TIMER - PIC12C508A, PIC12C509A, PIC12CE518, PIC12CE519, PIC12LC508A, PIC12LC509A, PIC12LCR509A, PIC12LCE518 and PIC12LCE519

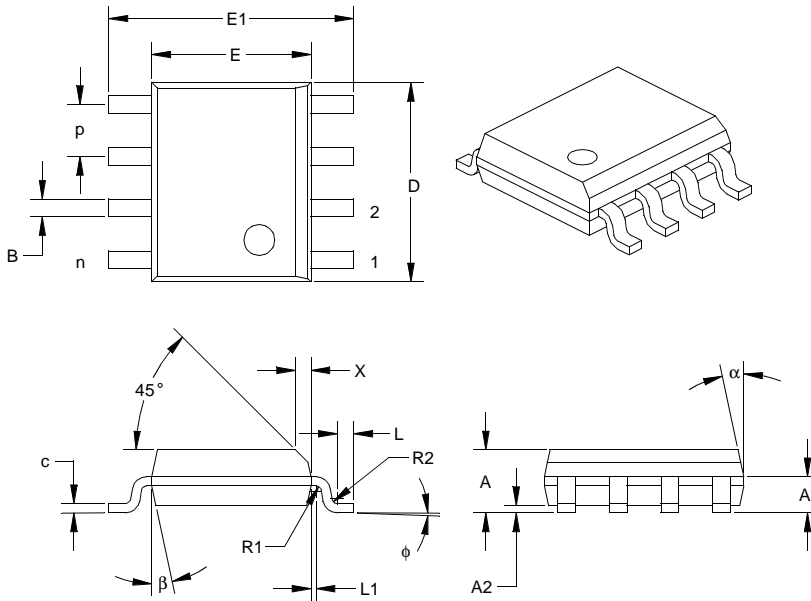
| AC Characteristics Standard Operating Conditions (unless otherwise specified) | | | | | | | |
|---|------|---|-------|--------------------|-------|-------|------------------------------------|
| Operating Temperature $0^{\circ}\text{C} \leq T_A \leq +70^{\circ}\text{C}$ (commercial) $-40^{\circ}\text{C} \leq T_A \leq +85^{\circ}\text{C}$ (industrial) $-40^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$ (extended) | | | | | | | |
| Operating Voltage V_{DD} range is described in Section 13.1 | | | | | | | |
| Parameter No. | Sym | Characteristic | Min | Typ ⁽¹⁾ | Max | Units | Conditions |
| 30 | TmcL | MCLR Pulse Width (low) | 2000* | — | — | ns | $V_{DD} = 5\text{ V}$ |
| 31 | Twdt | Watchdog Timer Time-out Period (No Prescaler) | 9* | 18* | 30* | ms | $V_{DD} = 5\text{ V}$ (Commercial) |
| 32 | TDRT | Device Reset Timer Period ⁽²⁾ | 9* | 18* | 30* | ms | $V_{DD} = 5\text{ V}$ (Commercial) |
| 34 | Tioz | I/O Hi-impedance from MCLR Low | — | — | 2000* | ns | |

* These parameters are characterized but not tested.

Note 1: Data in the Typical ("Typ") column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 2: See Table 13-6.

Package Type: K04-057 8-Lead Plastic Small Outline (SN) – Narrow, 150 mil



| Units | | INCHES* | | | MILLIMETERS | | |
|-------------------------|----------------|---------|-------|-------|-------------|------|------|
| Dimension Limits | | MIN | NOM | MAX | MIN | NOM | MAX |
| Pitch | p | | 0.050 | | | 1.27 | |
| Number of Pins | n | | 8 | | | 8 | |
| Overall Pack. Height | A | 0.054 | 0.061 | 0.069 | 1.37 | 1.56 | 1.75 |
| Shoulder Height | A1 | 0.027 | 0.035 | 0.044 | 0.69 | 0.90 | 1.11 |
| Standoff | A2 | 0.004 | 0.007 | 0.010 | 0.10 | 0.18 | 0.25 |
| Molded Package Length | D [‡] | 0.189 | 0.193 | 0.196 | 4.80 | 4.89 | 4.98 |
| Molded Package Width | E [‡] | 0.150 | 0.154 | 0.157 | 3.81 | 3.90 | 3.99 |
| Outside Dimension | E1 | 0.229 | 0.237 | 0.244 | 5.82 | 6.01 | 6.20 |
| Chamfer Distance | X | 0.010 | 0.015 | 0.020 | 0.25 | 0.38 | 0.51 |
| Shoulder Radius | R1 | 0.005 | 0.005 | 0.010 | 0.13 | 0.13 | 0.25 |
| Gull Wing Radius | R2 | 0.005 | 0.005 | 0.010 | 0.13 | 0.13 | 0.25 |
| Foot Length | L | 0.011 | 0.016 | 0.021 | 0.28 | 0.41 | 0.53 |
| Foot Angle | φ | 0 | 4 | 8 | 0 | 4 | 8 |
| Radius Centerline | L1 | 0.000 | 0.005 | 0.010 | 0.00 | 0.13 | 0.25 |
| Lead Thickness | c | 0.008 | 0.009 | 0.010 | 0.19 | 0.22 | 0.25 |
| Lower Lead Width | B [†] | 0.014 | 0.017 | 0.020 | 0.36 | 0.43 | 0.51 |
| Mold Draft Angle Top | α | 0 | 12 | 15 | 0 | 12 | 15 |
| Mold Draft Angle Bottom | β | 0 | 12 | 15 | 0 | 12 | 15 |

* Controlling Parameter.

† Dimension "B" does not include dam-bar protrusions. Dam-bar protrusions shall not exceed 0.003" (0.076 mm) per side or 0.006" (0.152 mm) more than dimension "B."

‡ Dimensions "D" and "E" do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.010" (0.254 mm) per side or 0.020" (0.508 mm) more than dimensions "D" or "E."

NOTES:

PIC12C5XX Product Identification System

| PART NO. | -XX | X | /XX | XXX | | | Examples |
|----------|-----|---|-----|-----|---------------------------|--|--|
| | | | | | Pattern: | Special Requirements | a) PIC12C508A-04/P Commercial Temp., PDIP Package, 4 MHz, normal VDD limits |
| | | | | | Package: | SN = 150 mil SOIC SM = 208 mil SOIC P = 300 mil PDIP JW = 300 mil Windowed Ceramic Side Brazed | b) PIC12C508A-04I/SM Industrial Temp., SOIC package, 4 MHz, normal VDD limits |
| | | | | | Temperature Range: | - = 0°C to +70°C I = -40°C to +85°C E = -40°C to +125°C | c) PIC12C509-04I/P Industrial Temp., PDIP package, 4 MHz, normal VDD limits |
| | | | | | Frequency Range: | 04 = 4 MHz | |
| | | | | | Device | PIC12C508 PIC12C509 PIC12C508T (Tape & reel for SOIC only) PIC12C509T (Tape & reel for SOIC only) PIC12C508A PIC12C509A PIC12C508AT (Tape & reel for SOIC only) PIC12C509AT (Tape & reel for SOIC only) PIC12LC508A PIC12LC509A PIC12LC508AT (Tape & reel for SOIC only) PIC12LC509AT (Tape & reel for SOIC only) PIC12CR509A PIC12CR509AT (Tape & reel for SOIC only) PIC12LCR509A PIC12LCR509AT (Tape & reel for SOIC only) PIC12CE518 PIC12CE518T (Tape & reel for SOIC only) PIC12CE519 PIC12CE519T (Tape & reel for SOIC only) PIC12LCE518 PIC12LCE518T (Tape & reel for SOIC only) PIC12LCE519 PIC12LCE519T (Tape & reel for SOIC only) | |

Please contact your local sales office for exact ordering procedures.

Sales and Support:

Data Sheets

Products supported by a preliminary Data Sheet may have an errata sheet describing minor operational differences and recommended workarounds. To determine if an errata sheet exists for a particular device, please contact one of the following:

1. Your local Microchip sales office
2. The Microchip Corporate Literature Center U.S. FAX: (602) 786-7277
3. The Microchip Worldwide Site (www.microchip.com)

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